

310000-8 PTO
10/026454
12/27/01

Jc3
866

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL. NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10026454	12/27/2001	257		2811	Williams

**APPLICANTS: Takeuchi Hiroki; Kojima Toshifumi; Ohbayashi Kazushige; Kashima
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**CONTINUING DATA VERIFIED:

NOTE-DISCLAIMER
The term of this patent shall not extend
beyond the expiration date
of Pat. No. 6,584,837

** FOREIGN APPLICATIONS VERIFIED:

JAPAN P.2000-401931 12/28/2000
JAPAN P.2001-255781 08/27/2001

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO Q67930
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		
Verified and Acknowledged Examiner's initials		
TITLE : Embedding resin and wiring substrate using the same		

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
ISSUE FEE		Sheets Drwg.	Figs. Drwg.
Amount Due	Date Paid	Print Fig.	
Primary Examiner		Application Examiner	
PREPARED FOR ISSUE		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	
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